DA5J109W

Silicon epitaxial planar type

For high speed switching circuits DA6X109W in SMini5 type package

Features

- Short reverse recovery time t_{rr}
- Contributes to miniaturization of sets, reduction of component count.
- Eco-friendly Halogen-free package
- Basic Part Number

Packaging

Embossed type (Thermo-compression sealing): 3000 pcs / reel (standard)

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit					
Reverse voltage	V _R	80	V					
Maximum peak reverse voltage	V _{RM}	80	V					
Forward current	I _F	100	mA					
Peak forward current *1	I _{FM}	225	mA					
Non-repetitive peak forward surge current *2	I _{FSM}	500	mA					
Junction temperature	Tj	150	°C					
Storage temperature	T _{stg}	-55 to +150	°C					

Note) *1: Value for single diode

*2: 1 t = 1 s

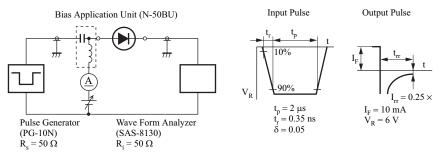
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _F	$I_F = 100 \text{ mA}$			1.2	V
Reverse voltage	V _R	$I_R = 100 \ \mu A$	80			V
Reverse current	I _R	$V_R = 80 V$			100	nA
Terminal capacitance	Ct	$V_{R} = 0 V, f = 1 MHz$			2	pF
Reverse recovery time *	t _{rr}	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}, I_{rr} = 0.25 \times I_R$			3	ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Absolute frequency of input and output is 100 MHz

3. *: t_{rr} measurement circuit



Package

Code

- SMini5-F3-B
- Pin Name
 - 1: Anode-1 4: Anode-3
 - 2: Cathode-1, 2, 3, 4 5: Anode-4
 - 3: Anode-2

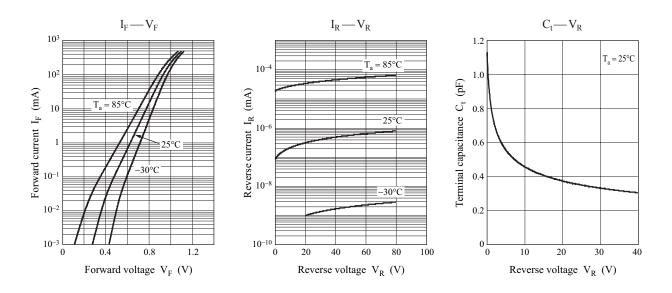
Marking Symbol: 28

Internal Connection



DA5J109W

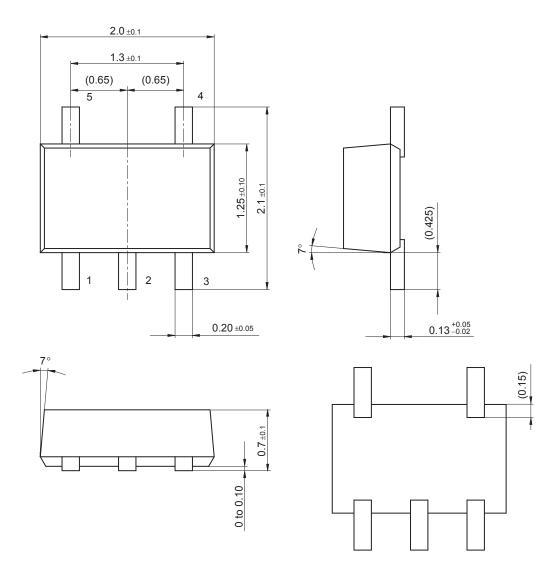
Panasonic



Panasonic

SMini5-F3-B

Unit: mm



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